

Precision, CMOS Analog Switches

ABSOLUTE MAXIMUM RATINGS

Voltage Referenced to V-

V+	+44V
GND	+25V
V _L	(GND - 0.3V) to (V+ + 0.3V)
I _N , COM, NC, NO	(V- - 2V) to (V+ + 2V) or 30mA, whichever occurs first
Continuous Current (any terminal)	30mA
Peak Current, NC, NO, COM (pulsed at 1ms, 10% duty cycle max)	100mA
ESD	±2000V

Continuous Power Dissipation (T_A = +70°C) (Note 1)

Plastic DIP (derate 9.09mW/°C above +70°C)	727mW
SO (derate 5.88mW/°C above +70°C)	471mW
CERDIP (derate 8.00mW/°C above +70°C)	640mW

Operating Temperature Ranges:

MAX31_C_	0°C to +70°C
MAX31_E_	-40°C to +85°C
MAX31_MJA	-55°C to +125°C
Storage Temperature Range	-55°C to +150°C
Lead Temperature (soldering, 10sec)	+300°C

Note 1: All leads are soldered or welded to PC board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS — Dual Supplies

(V+ = 15V, V- = -15V, V_L = 5V, GND = 0V, V_{INL} = 0.8V, V_{INH} = 2.4V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP.	MIN	TYP (Note 2)	MAX	UNITS
Analog-Signal Range	V _{COM} , V _{NO} , V _{NC}	(Note 3)		-15		15	V
On Resistance	R _{ON}	V _{COM} = ±12.5V, I _(NC OR NO) = -10mA, V+ = 13.5V, V- = -13.5V	T _A = +25°C		20	35	Ω
						30	
			T _A = T _{MIN} to T _{MAX}			45	
On Resistance Match Between Channels (Note 4)	R _{ON}	I _(NC OR NO) = -10mA, V _{COM} = 10V or -10V, V+ = 15V, V- = -15V	T _A = +25°C			2	Ω
			T _A = T _{MIN} to T _{MAX}			3	
On Resistance Flatness (Note 4)	R _{ON}	I _(NC OR NO) = -10mA, V _{COM} = 5V or -5V, V+ = 15V, V- = -15V	T _A = +25°C			3	Ω
			T _A = T _{MIN} to T _{MAX}			5	
NO or NC Off Leakage Current	I _{NC(OFF)} or I _{NO(OFF)}	V+ = 16.5V, V- = -16.5V, V _{COM} = ±15.5V, V _{NC} or V _{NO} = ±15.5V	T _A = +25°C	-0.25		0.25	nA
			C, E		-6	6	
			M		-20	20	
COM Off Leakage Current	I _{COM(OFF)}	V+ = 16.5V, V- = -16.5V, V _{COM} = ±15.5V, V _{NC} or V _{NO} = ±15.5V	MAX317, MAX318	T _A = +25°C	-0.25	-0.1	nA
				C, E		6	
				M		20	
			MAX319	T _A = +25°C	-0.75	-0.1	
				C, E		10	
				M		60	
COM On Leakage Current	I _{COM(ON)}	V+ = 16.5V, V- = -16.5V, V _{NC} or V _{NO} = V _D = ±15.5V	MAX317, MAX318	T _A = +25°C	-0.4		nA
				C, E		10	
				M		40	
			MAX319	T _A = +25°C	-0.75		
				C, E		10	
				M		60	

Precision, CMOS Analog Switches

ELECTRICAL CHARACTERISTICS — Dual Supplies (continued)

(V+ = 15V, V- = -15V, V_L = 5V, GND = 0V, V_{INL} = 0.8V, V_{INH} = 2.4V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		TEMP.	MIN	TYP (Note 2)	MAX	UNITS
LOGIC INPUT								
Logic Input Current (Input Voltage High)	I _{IH}	V _{IN} = 2.4V			-0.5	0.005	0.5	μA
Logic Input Current (Input Voltage Low)	I _{IL}	V _{IN} = 0.8V			-0.5	0.005	0.5	μA
DYNAMIC								
Turn-On Time	t _{ON}	MAX317, MAX318, Figure 2, V _{COM} = ±10V		T _A = +25°C		100	175	ns
				T _A = T _{MIN} to T _{MAX}			250	
Turn-Off Time	t _{OFF}	MAX317, MAX318, Figure 2, V _{COM} = ±10V		T _A = +25°C		60	145	ns
				T _A = T _{MIN} to T _{MAX}			210	
Transition Time	t _{TRANS}	MAX319, Figure 3, V _{NO} = ±10V, V _{NC} = ±10V		T _A = +25°C			175	ns
				T _A = T _{MIN} to T _{MAX}			250	
Break-Before-Make Interval	t _D	MAX319, Figure 4, V _{NO} = V _{NC} = ±10V		T _A = +25°C	5	13		ns
Charge Injection	Q	V _{GEN} = 0V, Figure 5		T _A = +25°C		3	10	pC
Off Isolation (Note 5)	OIRR	R _L = 50Ω, C _L = 5pF, f = 1MHz, Figure 7		T _A = +25°C		68		dB
Crosstalk (Note 6)		R _L = 50Ω, C _L = 5pF, f = 1MHz, Figure 8		T _A = +25°C		85		dB
COM Off Capacitance	C _{COM(OFF)}	V _{COM} = 0V, f = 1MHz, Figure 8		T _A = +25°C		8		pF
Off Capacitance NC or NO	C _(OFF)	V _{COM} = 0V, f = 1MHz, Figure 8		T _A = +25°C		8		pF
Channel-On Capacitance COM Terminal	C _{COM(ON)}	V _S = 0V, f = 1MHz, Figure 9	MAX317, MAX318	T _A = +25°C		30		pF
			MAX319			35		
SUPPLY								
Positive Supply Current	I ⁺	V _{IN} = 0V or 5V, V ⁺ = 16.5V, V ⁻ = -16.5V		T _A = +25°C	-1	0.0001	1	μA
				T _A = T _{MIN} to T _{MAX}	-5		5	
Negative Supply Current	I ⁻	V _{IN} = 0V or 5V, V ⁺ = 16.5V, V ⁻ = -16.5V		T _A = +25°C	-1	-0.0001	1	μA
				T _A = T _{MIN} to T _{MAX}	-5		5	
Logic Supply Current	I _L	V _{IN} = 0V or 5V, V ⁺ = 16.5V, V ⁻ = -16.5V		T _A = +25°C	-1	0.0001	1	μA
				T _A = T _{MIN} to T _{MAX}	-5		5	
Ground Current	I _{GND}	V _{IN} = 0V or 5V, V ⁺ = 16.5V, V ⁻ = -16.5V		T _A = +25°C	-1	-0.0001	1	μA
				T _A = T _{MIN} to T _{MAX}	-5		5	

MAX317/MAX318/MAX319

Precision, CMOS Analog Switches

ELECTRICAL CHARACTERISTICS — Single Supply

(V+ = 12V, V- = 0V, V_L = 5V, GND = 0V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP (Note 2)	MAX	UNITS
SWITCH						
Analog-Signal Range	V _{COM} , V _{NO} , V _{NC}	(Note 3)	0		12	V
Drain-Source On Resistance	R _(ON)	I _(NC or NO) = -10mA, V _{COM} = 3.8V, V+ = 10.8V		40	100	Ω
DYNAMIC						
Turn-On Time	t _{ON}	V _{COM} = 8V, Figure 2		110		ns
Turn-Off Time	t _{OFF}	V _{COM} = 8V, Figure 2		40		ns
Break-Before-Make Time Delay	t _D	MAX319, R _L = 1000Ω, C _L = 35pF, Figure 4		60		ns
Charge Injection	Q	C _L = 10nF, V _{GEN} = 0V, R _{GEN} = 0V, Figure 5		2	10	pC
SUPPLY						
Positive Supply Current	I+	V+ = 13.2V, all channels on or off, V _{IN} = 0V or 5V, V _L = 5.25V		0.0001		μA
Negative Supply Current	I-	V+ = 13.2V, all channels on or off, V _{IN} = 0V or 5V, V _L = 5.25V		0.0001		μA
Logic Supply Current	I _L	V _L = 5.25V, all channels on or off, V _{IN} = 0V or 5V		0.0001		μA
Ground Current	I _{GND}	V _L = 5.25V, all channels on or off, V _{IN} = 0V or 5V		-0.0001		μA

Note 2: Typical values are for **design aid only**, not guaranteed, not subject to production testing.

Note 3: Guaranteed by design.

Note 4: On resistance match between channels and flatness are guaranteed only with bipolar-supply operation.

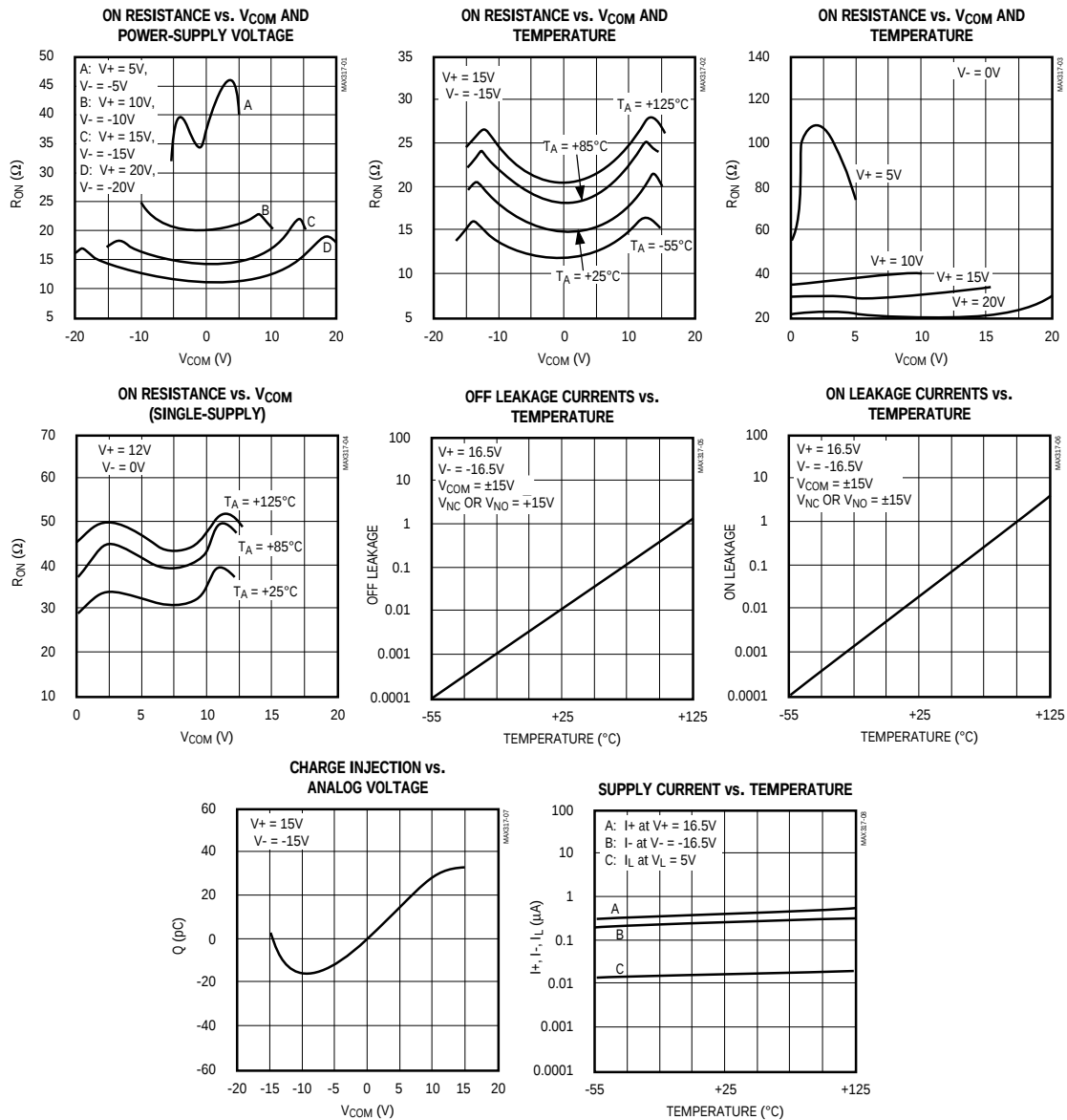
Note 5: Off Isolation = $20\log_{10} \left(\frac{V_{COM}}{V_{NC} \text{ or } V_{NO}} \right)$, V_{COM} = output, V_{NC} or V_{NO} = input to off switch.

Note 6: Between any two switches.

Precision, CMOS Analog Switches

Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted).



MAX317/MAX318/MAX319

Precision, CMOS Analog Switches

Pin Description

PIN			NAME	FUNCTION
MAX317	MAX318	MAX319		
1	1	1	COM	Analog-switch common terminal
2	2	—	N.C.	No connect — not internally connected
—	—	8	NO	Analog-switch normally open terminal
3	3	3	GND	Logic ground
4	4	4	V+	Analog-signal positive supply input
5	5	5	VL	Logic-level positive supply input
6	6	6	IN	Logic-level input
7	7	7	V-	Analog-signal negative supply input
8	—	2	NC	Analog-switch normally closed terminal
—	8	—	NO	Analog-switch normally open terminal

Applications Information

Operation with Supply Voltages Other Than $\pm 15\text{V}$

The main limitation of supply voltages other than $\pm 15\text{V}$ is analog signal range reduction. The MAX317/MAX318/MAX319 switches operate with bipolar supplies of $\pm 5\text{V}$ to $\pm 20\text{V}$. Typical Operating Characteristics graphs show typical on resistance for $\pm 15\text{V}$, $\pm 10\text{V}$, and $\pm 5\text{V}$ supplies. Switching times increase by a factor of two or more for operation at $\pm 5\text{V}$. The MAX317/MAX318/MAX319 can operate from unipolar supplies of $+10\text{V}$ to $+30\text{V}$. Both parts can also operate from unbalanced supplies such as $+24\text{V}$ and -5V .

Connect V- to 0V when operating with a single supply. This means that VL must be connected to $+5\text{V}$ to be TTL compatible, or to V+ for CMOS logic input levels.

Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. It is important not to exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V+ on first, followed by VL, V-, and logic inputs. If power-supply sequencing is not possible, protect the devices from overvoltage by

adding two small signal diodes in series with the supply pins (Figure 1). Adding the diodes reduces the analog signal range to 1V below V+ and 1V below V-, but low switch resistance and low leakage characteristics are unaffected. Device operation is unchanged, and the difference between V+ to V- should not exceed $+44\text{V}$.

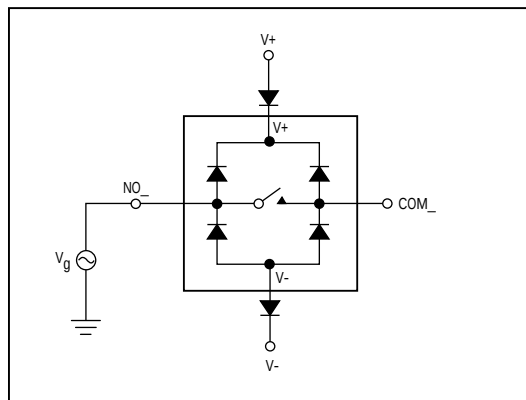


Figure 1. Overvoltage Protection Using Blocking Diodes

Precision, CMOS Analog Switches

Test Circuits/Timing Diagrams

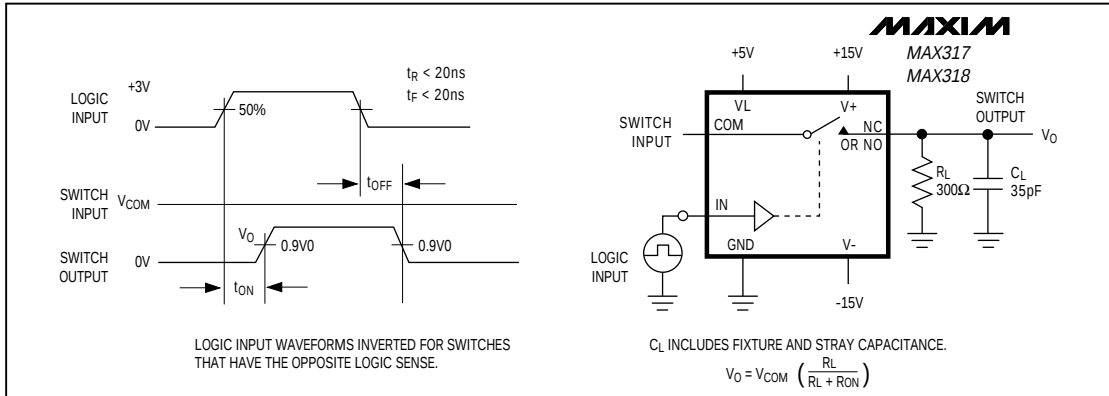


Figure 2. MAX317/MAX318 Switching-Time Test Circuit

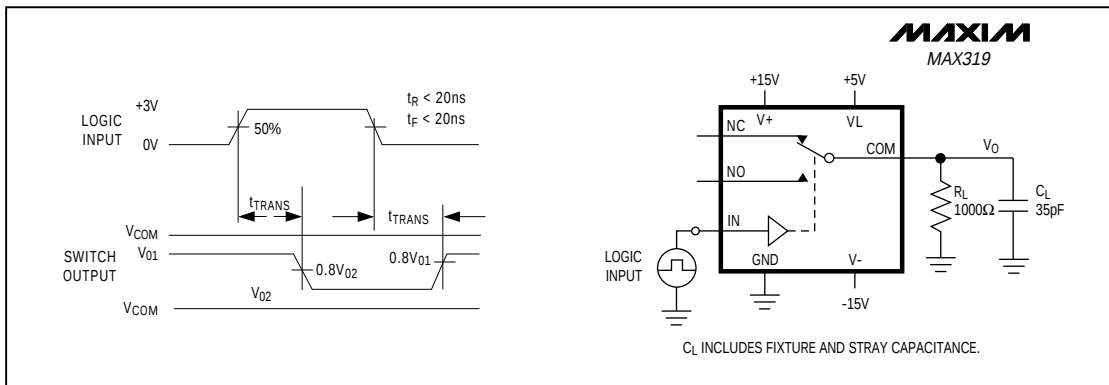


Figure 3. MAX319 Transition Time

MAX317/MAX318/MAX319

Precision, CMOS Analog Switches

Test Circuits/Timing Diagrams (continued)

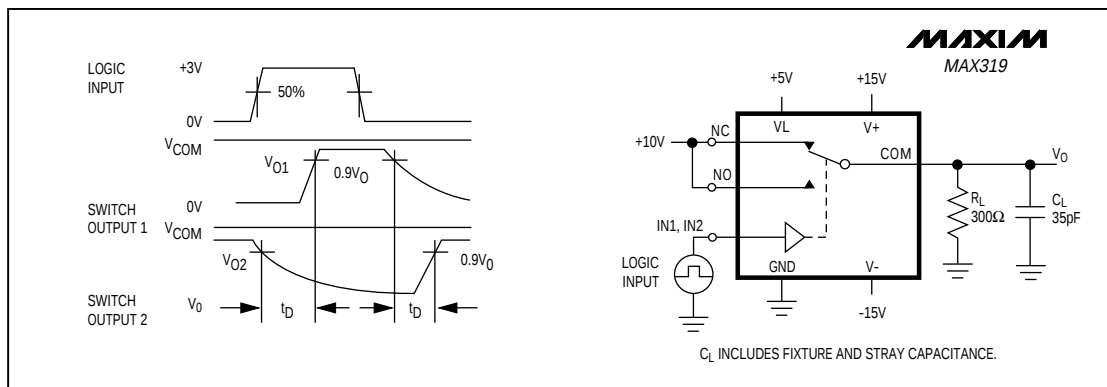


Figure 4. MAX319 Break-Before-Make Test Circuit

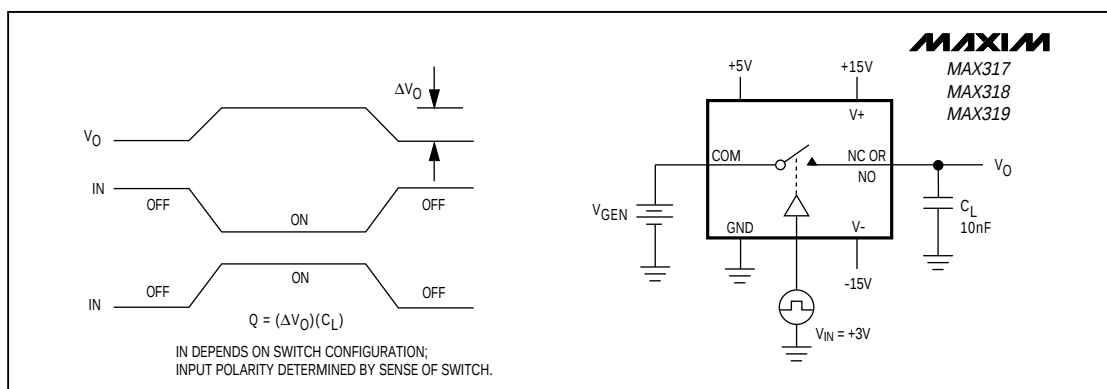


Figure 5. Charge-Injection Test Circuit

Precision, CMOS Analog Switches

Test Circuits/Timing Diagrams (continued)

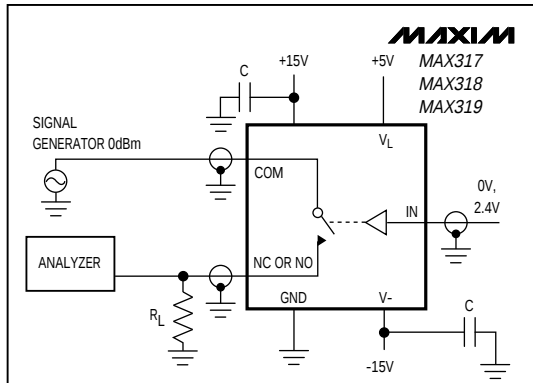


Figure 6. Off-Isolation Test Circuit

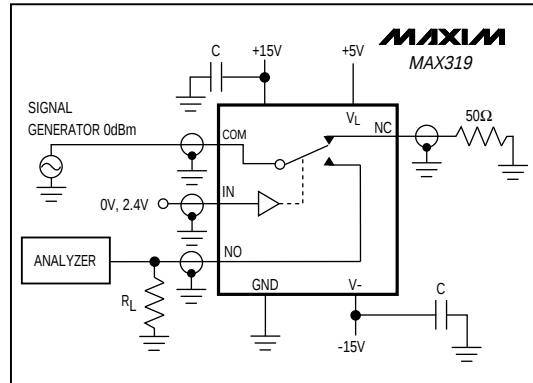


Figure 7. MAX319 Crosstalk Test Circuit

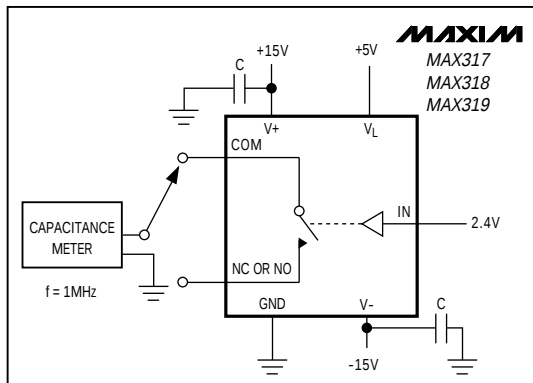


Figure 8. Channel-Off Capacitance Test Circuit

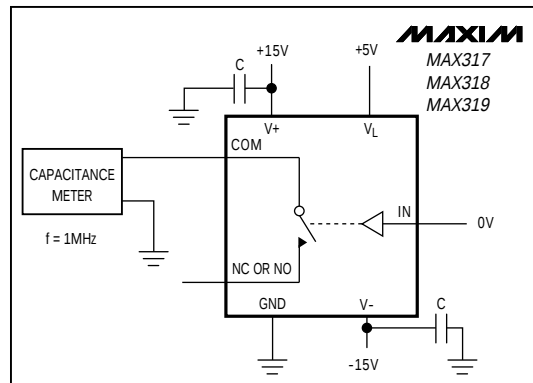


Figure 9. Channel-On Capacitance Test Circuit

MAX317/MAX318/MAX319

Precision, CMOS Analog Switches

MAX317/MAX318/MAX319

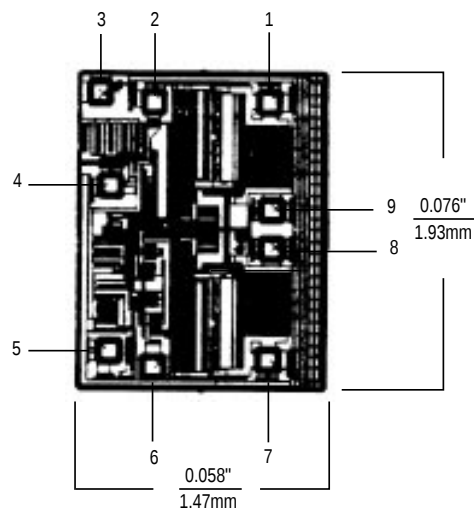
Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE
MAX318CPA	0°C to +70°C	8 Plastic DIP
MAX318CSA	0°C to +70°C	8 SO
MAX318CJA	0°C to +70°C	8 CERDIP
MAX318C/D	0°C to +70°C	Dice*
MAX318EPA	-40°C to +85°C	8 Plastic DIP
MAX318ESA	-40°C to +85°C	8 SO
MAX318EJA	-40°C to +85°C	8 CERDIP
MAX318MJA	-55°C to +125°C	8 CERDIP**
MAX319CPA	0°C to +70°C	8 Plastic DIP
MAX319CSA	0°C to +70°C	8 SO
MAX319CJA	0°C to +70°C	8 CERDIP
MAX319C/D	0°C to +70°C	Dice*
MAX319EPA	-40°C to +85°C	8 Plastic DIP
MAX319ESA	-40°C to +85°C	8 SO
MAX319EJA	-40°C to +85°C	8 CERDIP
MAX319MJA	-55°C to +125°C	8 CERDIP**

* Contact factory for dice specifications.

** Contact factory for availability and processing to MIL-STD-883.

Chip Topography



TRANSISTOR COUNT: 32;

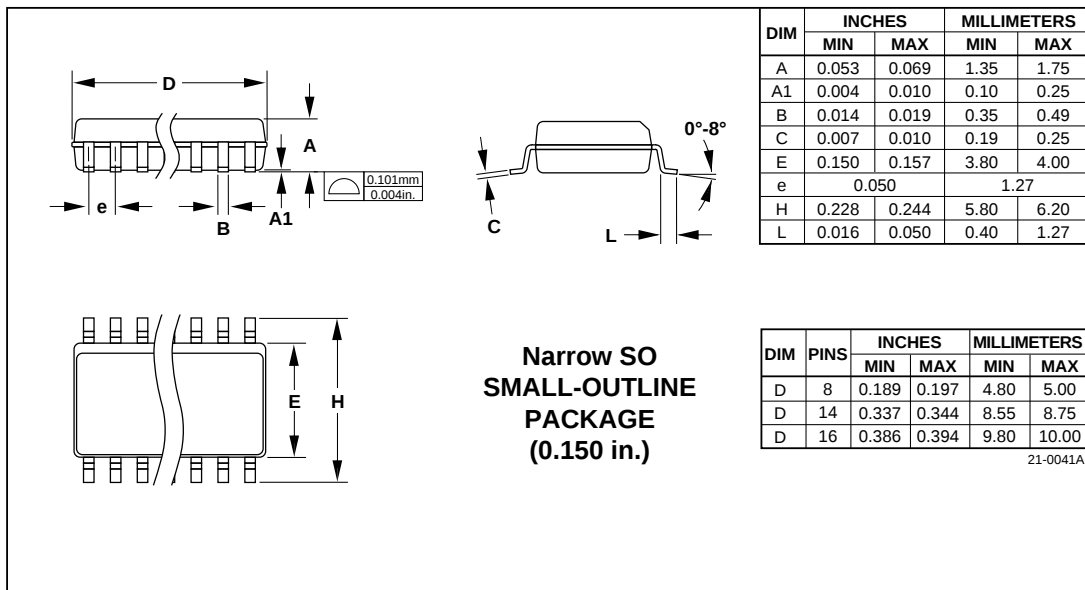
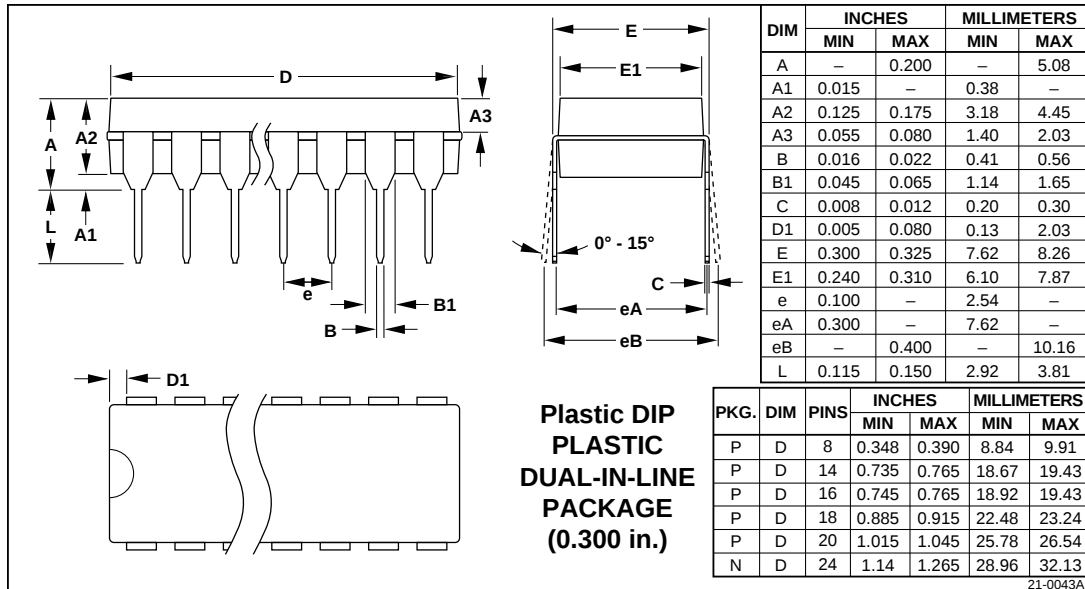
SUBSTRATE CONNECTED TO V+.

DIE PAD	MAX317	MAX318	MAX319
1	COM	NC	NC
2	GND	GND	GND
3	V+	V+	V+
4	VL	VL	VL
5	IN	IN	IN
6	V-	V-	V-
7	N.C.	NO	NO
8	N.C.	COM	COM
9	NC	NC	COM

Precision, CMOS Analog Switches

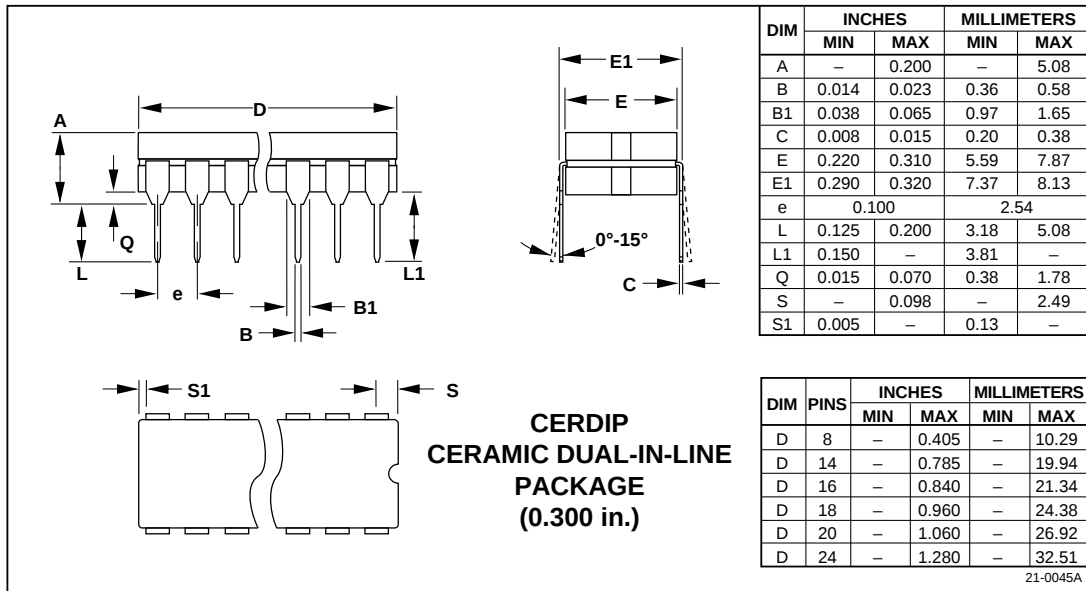
Package Information

MAX317/MAX318/MAX319



Precision, CMOS Analog Switches

Package Information



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

12 _____ Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 (408) 737-7600

© 1994 Maxim Integrated Products

Printed USA

MAXIM is a registered trademark of Maxim Integrated Products.